# **Sensitive Gate Triacs**

# **Silicon Bidirectional Thyristors**

Designed primarily for ac power switching. The gate sensitivity of these triacs permits the use of economical transistorized or integrated circuit control circuits, and it enhances their use in low-power phase control and load-switching applications.

#### Features

- Very High Gate Sensitivity
- Low On-State Voltage at High Current Levels
- Glass-Passivated Chip for Stability
- Small, Rugged Thermopad Construction for Low Thermal Resistance, High Heat Dissipation and Durability
- Pb–Free Package is Available\*

#### MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Repetitive Off-State Voltage (Note 1) $(T_J = 25 \text{ to } 110^{\circ}\text{C}, \text{ Gate Open})$	V <sub>DRM,</sub> V <sub>RRM</sub>	200	V
On-State RMS Current ( $T_C = 70^{\circ}C$ ) (Full Cycle Sine Wave 50 to 60 Hz)	I <sub>T(RMS)</sub>	2.5	A
Peak Non–Repetitive Surge Current (One Full Cycle, Sine Wave 60 Hz, T <sub>C</sub> = 70°C)	I <sub>TSM</sub>	25	A
Circuit Fusing Consideration (t = 8.3 ms)	l <sup>2</sup> t	2.6	A <sup>2</sup> s
Peak Gate Power (Pulse Width $\leq$ 10 $\mu$ s, T <sub>C</sub> = 70°C)	P <sub>GM</sub>	10	W
Average Gate Power (t = 8.3 ms, $T_C = 70^{\circ}C$ )	P <sub>G(AV)</sub>	0.5	W
Peak Gate Current (Pulse Width = 10 $\mu$ s, T <sub>C</sub> = 70°C)	I <sub>GM</sub>	0.5	A
Operating Junction Temperature Range	TJ	-40 to +110	°C
Storage Temperature Range	T <sub>stg</sub>	-40 to +150	°C
Mounting Torque (6-32 Screw) (Note 2)	-	8.0	in. lb.

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. V<sub>DRM</sub> and V<sub>RRM</sub> for all types can be applied on a continuous basis. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

 Torque rating applies with use of torque washer (Shakeproof WD19523 or equivalent). Mounting Torque in excess of 6 in. lb. does not appreciably lower case-to-sink thermal resistance. Main terminal 2 and heat-sink contact pad are common.



## **ON Semiconductor®**

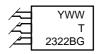
http://onsemi.com

TRIACS 2.5 AMPERES RMS 200 VOLTS





#### MARKING DIAGRAM



Y = Year WW = Work Week T2322B = Device Code G = Pb-Free Package

	PIN ASSIGNMENT
1	Main Terminal 1
2	Main Terminal 2
3	Gate

### **ORDERING INFORMATION**

Device	Package	Shipping
T2322B	TO225AA	500 Units/Box
T2322BG	TO225AA (Pb–Free)	500 Units/Box

\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

## T2322B

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\thetaJC}$	3.5	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\thetaJA}$	60	°C/W
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Sec	ΤL	260	°C

**ELECTRICAL CHARACTERISTICS** ( $T_C = 25^{\circ}C$  unless otherwise noted; Electricals apply in both directions)

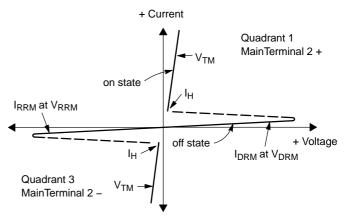
Characteristic		Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Peak Repetitive Blocking Current (V <sub>D</sub> = Rated V <sub>DRM</sub> , V <sub>RRM</sub> ; Gate Open)	$T_J = 25^{\circ}C$ $T_J = 110^{\circ}C$	I <sub>DRM,</sub> I <sub>RRM</sub>		_ 0.2	10 0.75	μA mA
ON CHARACTERISTICS				•		
Peak On-State Voltage (Note 3) $(I_{TM} = \pm 10 \text{ A})$		V <sub>TM</sub>	-	1.7	2.2	V
Gate Trigger Current (Continuous dc) $(V_D = 12 V, R_L = 100 \Omega)$ All Quadrants		I <sub>GT</sub>	-	-	10	mA
Gate Trigger Voltage (Continuous dc) ( $V_D = 12 \text{ Vdc}, R_L = 100 \Omega, T_C = 25^{\circ}\text{C}$ )	V <sub>GT</sub>	-	1.0	2.2	V	
Gate Non–Trigger Voltage ( $V_D$ = 12 V, R <sub>L</sub> = 100 $\Omega$ , T <sub>C</sub> = 110°C)		V <sub>GD</sub>	0.15	-	-	V
Holding Current ( $V_D = 12 V$ , $I_T$ (Initiating Current) = ±200 mA, Gate Open)		Ι <sub>Η</sub>	-	15	30	mA
Gate Controlled Turn-On Time ( $V_D$ = Rated V <sub>DRM</sub> , I <sub>TM</sub> = 10 A pk, I <sub>G</sub> = 60 mA, tr = 0.1 µsec)		t <sub>gt</sub>	-	1.8	2.5	μS
DYNAMIC CHARACTERISTICS						
Critical Rate-of-Rise of Off-State Voltage ( $V_D$ = Rated $V_{DRM}$ , Exponential Waveform, $T_C$ = 100°C)		dv/dt	10	100	-	V/µs
Critical Rate-of-Rise of Commutation Voltage ( $V_D$ = Rated $V_{DRM}$ , $I_{TM}$ = 3.5 A pk, Commutating di/dt = 1.26 A/ms, Gate Unenergized, $T_C$ = 90°C)		dv/dt(c)	1.0	4.0	_	V/µs

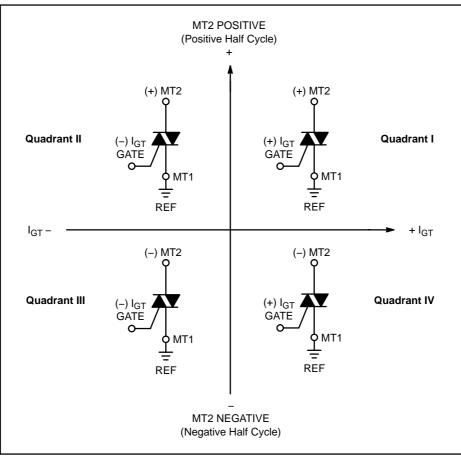
3. Pulse Test: Pulse Width  $\leq$  1.0 ms, Duty Cycle  $\leq$  2%.

## T2322B

## Voltage Current Characteristic of Triacs (Bidirectional Device)

Symbol	Parameter
V <sub>DRM</sub>	Peak Repetitive Forward Off State Voltage
I <sub>DRM</sub>	Peak Forward Blocking Current
V <sub>RRM</sub>	Peak Repetitive Reverse Off State Voltage
I <sub>RRM</sub>	Peak Reverse Blocking Current
V <sub>TM</sub>	Maximum On State Voltage
I <sub>H</sub>	Holding Current





### **Quadrant Definitions for a Triac**

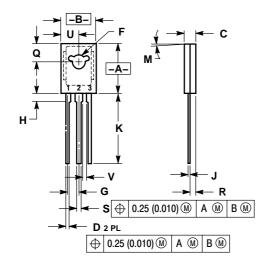
All polarities are referenced to MT1.

With in-phase signals (using standard AC lines) quadrants I and III are used.

## T2322B

#### PACKAGE DIMENSIONS

TO-225 CASE 77-09 **ISSUE Z** 



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

 CONTROLLING DIMENSION: INCH.
077-01 THRU -08 OBSOLETE, NEW STANDARD 077-09

	INCHES			IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.425	0.435	10.80	11.04
В	0.295	0.305	7.50	7.74
С	0.095	0.105	2.42	2.66
D	0.020	0.026	0.51	0.66
F	0.115	0.130	2.93	3.30
G	0.094	BSC	2.39 BSC	
Н	0.050	0.095	1.27	2.41
J	0.015	0.025	0.39	0.63
Κ	0.575	0.655	14.61	16.63
Μ	5° TYP		5° TYP	
Q	0.148	0.158	3.76	4.01
R	0.045	0.065	1.15	1.65
S	0.025	0.035	0.64	0.88
U	0.145	0.155	3.69	3.93
v	0.040		1.02	

3. GATE

ON Semiconductor and 💷 are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC products are not designed, intended, or authorized for use a components in systems intended for surgical implant into the body, or other applications and actual performance may any content applications. intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, ad distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, and claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303–675–2176 or 800–344–3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support:

Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81-3-5773-3850

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative